

MOSFETs Silicon N-Channel MOS (DTMOSVI)

TK110A65Z

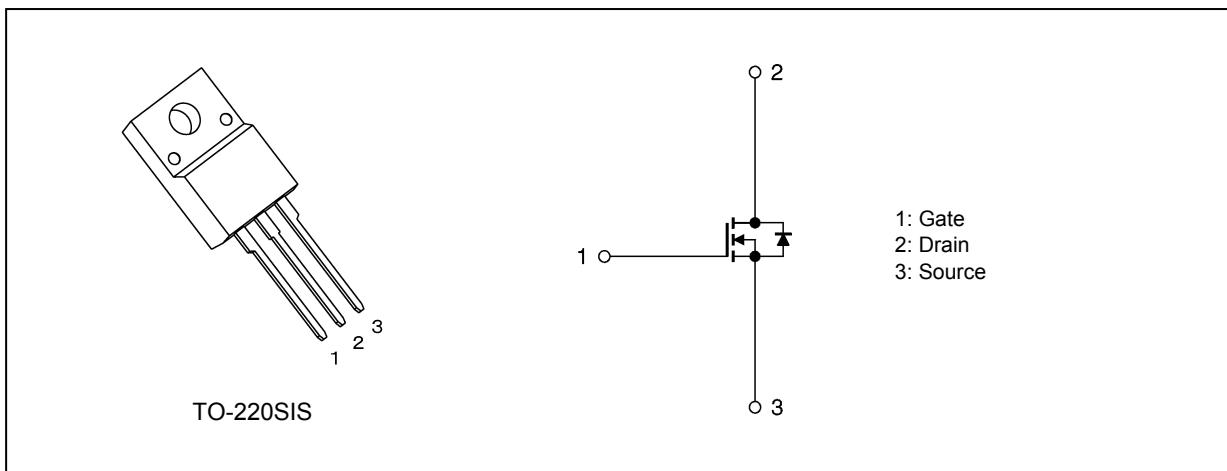
1. Applications

- Switching Power Supplies

2. Features

- (1) Low drain-source on-resistance: $R_{DS(ON)} = 0.092 \Omega$ (typ.)
- (2) High-speed switching properties with the lower capacitance.
- (3) Enhancement mode: $V_{th} = 3$ to 4 V ($V_{DS} = 10$ V, $I_D = 1.02$ mA)

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) ($T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Rating	Unit
Drain-source voltage	V_{DSS}	650	V
Gate-source voltage	V_{GSS}	± 30	
Drain current (DC)	I_D	24	A
Drain current (pulsed)	I_{DP}	96	
Power dissipation ($T_c = 25$ °C)	P_D	45	W
Single-pulse avalanche energy	E_{AS}	258	mJ
Single-pulse avalanche current	I_{AS}	6	A
Reverse drain current (DC)	I_{DR}	24	
Reverse drain current (pulsed)	I_{DRP}	96	
Channel temperature	T_{ch}	150	°C
Storage temperature	T_{stg}	-55 to 150	
Isolation voltage (RMS)	$V_{ISO(RMS)}$	2000	V
Mounting torque	T_{OR}	0.6	N · m

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Start of commercial production
2020-02

5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	$R_{th(ch-c)}$	2.77	°C/W
Channel-to-ambient thermal resistance	$R_{th(ch-a)}$	62.5	

Note 1: Ensure that the channel temperature does not exceed 150 °C.

Note 2: $V_{DD} = 90$ V, $T_{ch} = 25$ °C (initial), $L = 12.7$ mH, $I_{AS} = 6$ A

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

6. Electrical Characteristics

6.1. Static Characteristics ($T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	I_{GSS}	$V_{GS} = \pm 30\text{ V}$, $V_{DS} = 0\text{ V}$	—	—	± 1	μA
Drain cut-off current	I_{DSS}	$V_{DS} = 650\text{ V}$, $V_{GS} = 0\text{ V}$	—	—	2	
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 10\text{ mA}$, $V_{GS} = 0\text{ V}$	650	—	—	
Gate threshold voltage	V_{th}	$V_{DS} = 10\text{ V}$, $I_D = 1.02\text{ mA}$	3	—	4	
Drain-source on-resistance	$R_{DS(ON)}$	$V_{GS} = 10\text{ V}$, $I_D = 12\text{ A}$	—	0.092	0.11	Ω

6.2. Dynamic Characteristics ($T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Input capacitance	C_{iss}	$V_{DS} = 300\text{ V}$, $V_{GS} = 0\text{ V}$, $f = 100\text{ kHz}$	—	2250	—	pF
Reverse transfer capacitance	C_{rss}		—	1.9	—	
Output capacitance	C_{oss}		—	54	—	
Effective output capacitance	$C_{o(er)}$	$V_{DS} = 0$ to 400 V , $V_{GS} = 0\text{ V}$	—	85	—	pF
Gate resistance	r_g	$V_{DS} = \text{OPEN}$, $f = 1\text{ MHz}$	—	3.4	—	Ω
Switching time (rise time)	t_r	See Figure 6.2.1	—	28	—	ns
Switching time (turn-on time)	t_{on}		—	52	—	
Switching time (fall time)	t_f		—	4	—	
Switching time (turn-off time)	t_{off}		—	90	—	ns
MOSFET dv/dt ruggedness	dv/dt	$V_{DS} \leq V_{(BR)DSS}$, $I_D \leq 12\text{ A}$	90	—	—	V/ns

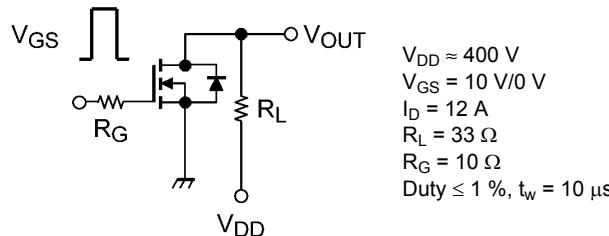


Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics ($T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Q_g	$V_{DD} \approx 400\text{ V}$, $V_{GS} = 10\text{ V}$, $I_D = 24\text{ A}$	—	40	—	nC
Gate-source charge 1	Q_{gs1}		—	13	—	
Gate-drain charge	Q_{gd}		—	11	—	

6.4. Source-Drain Characteristics ($T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Diode forward voltage	V_{DSF}	$I_{DR} = 24\text{ A}$, $V_{GS} = 0\text{ V}$	—	—	-1.7	V
Reverse recovery time	t_{rr}	$V_{DD} = 400\text{ V}$, $I_{DR} = 12\text{ A}$, $V_{GS} = 0\text{ V}$	—	300	—	ns
Reverse recovery charge	Q_{rr}	$-dI_{DR}/dt = 100\text{ A}/\mu\text{s}$	—	3.9	—	μC
Peak reverse recovery current	I_{rr}		—	26	—	A
Diode dv/dt ruggedness	dv/dt	$V_{DD} \leq 400\text{ V}$, $I_{DR} \leq 12\text{ A}$, $V_{GS} = 0\text{ V}$	40	—	—	V/ns

7. Marking (Note)

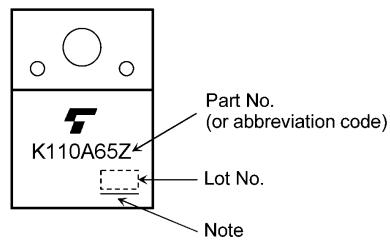


Fig. 7.1 Marking

Note: A line under a Lot No. identifies the indication of product Labels.

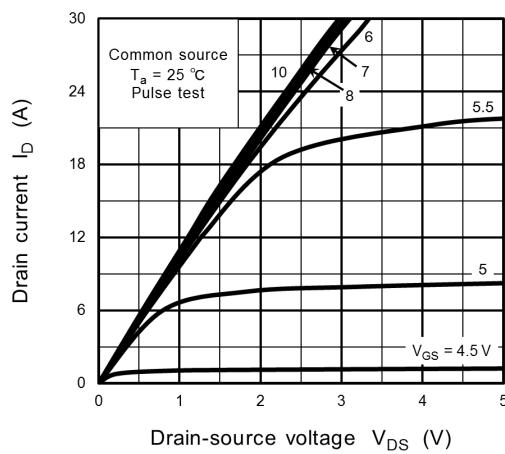
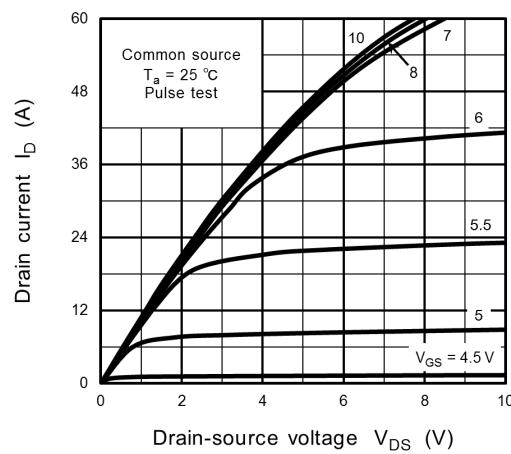
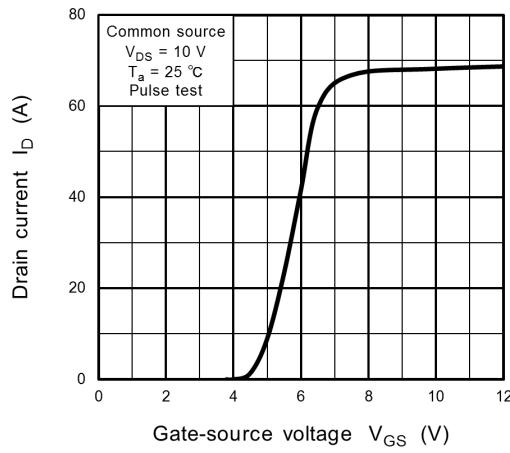
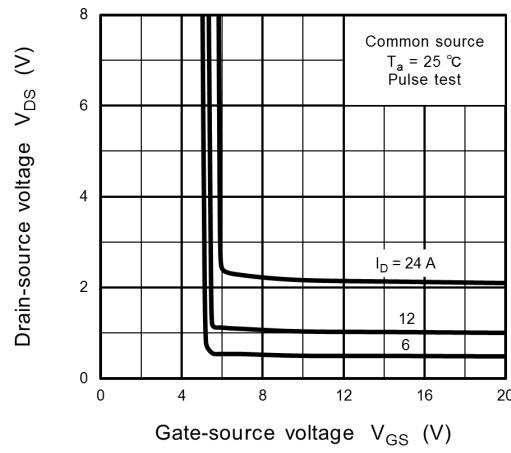
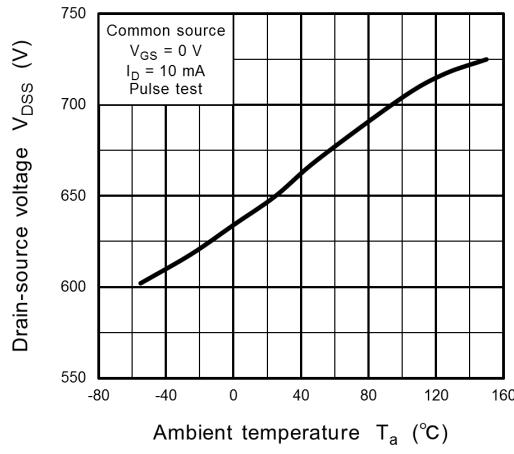
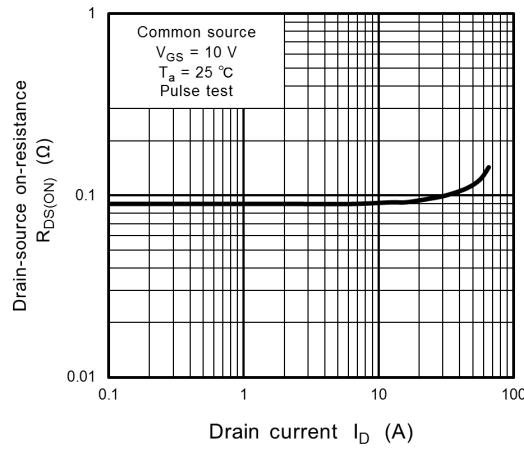
Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

8. Characteristics Curves (Note)

Fig. 8.1 I_D - V_{DS} Fig. 8.2 I_D - V_{DS} Fig. 8.3 I_D - V_{GS} Fig. 8.4 V_{DS} - V_{GS} Fig. 8.5 V_{DS} - T_a Fig. 8.6 $R_{DS(\text{ON})}$ - I_D

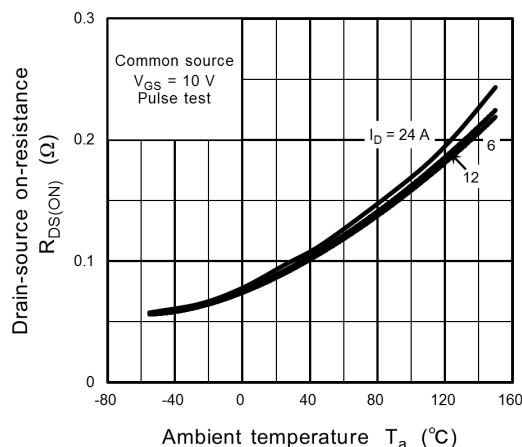


Fig. 8.7 $R_{DS(ON)} - T_a$

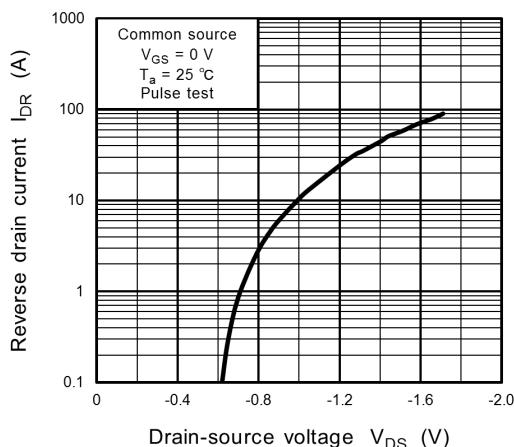


Fig. 8.8 $I_{DR} - V_{DS}$

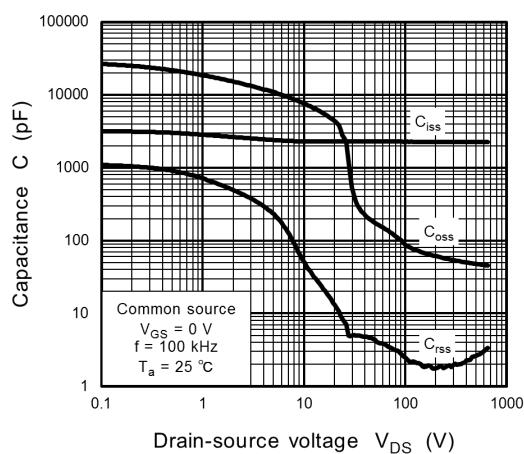


Fig. 8.9 $C - V_{DS}$

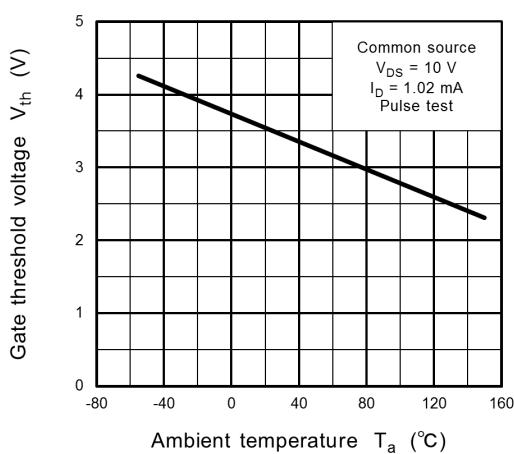


Fig. 8.10 $V_{th} - T_a$

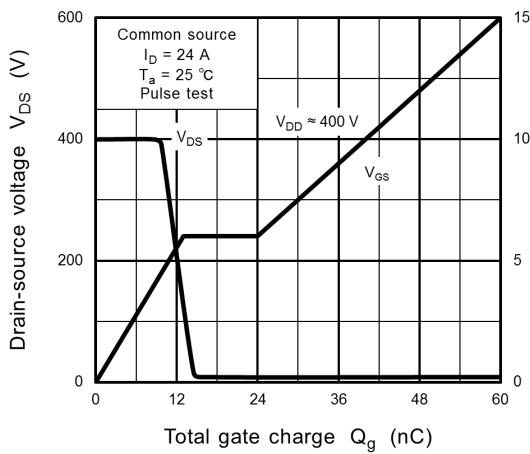


Fig. 8.11 Dynamic Input/Output Characteristics

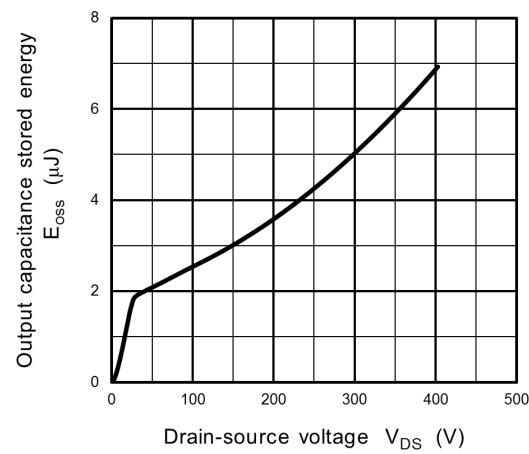
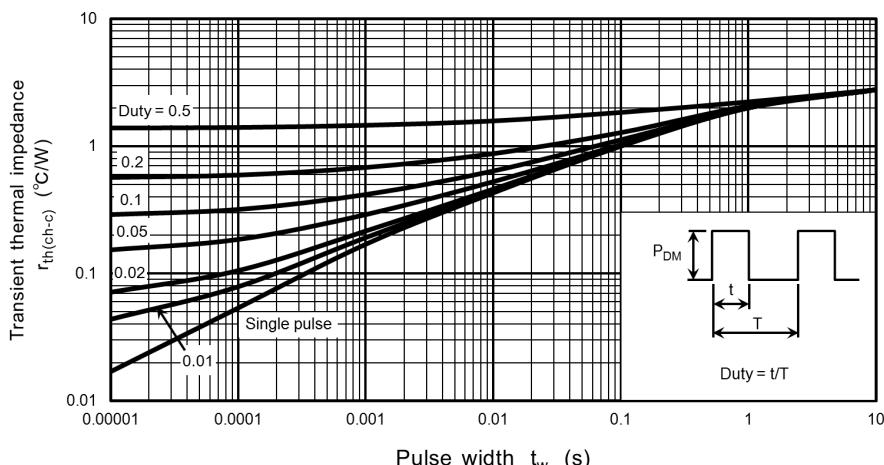
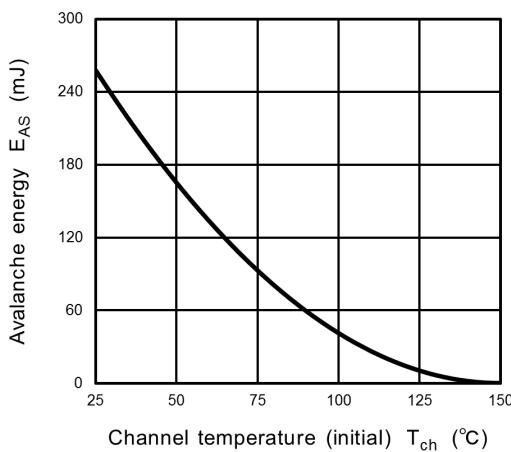


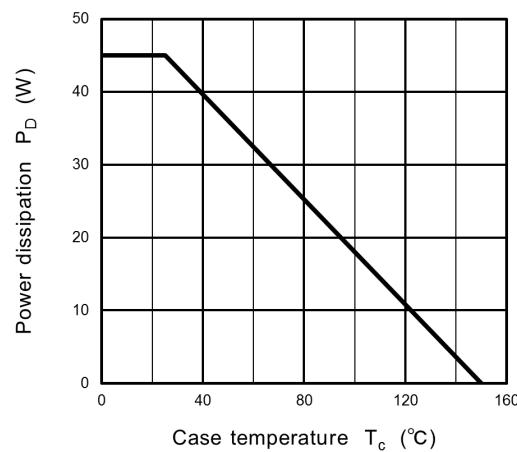
Fig. 8.12 $E_{oss} - V_{DS}$



**Fig. 8.13 $r_{th} - t_w$
(Guaranteed Maximum)**



**Fig. 8.14 $E_{AS} - T_{ch}$
(Guaranteed Maximum)**



**Fig. 8.15 $P_D - T_c$
(Guaranteed Maximum)**

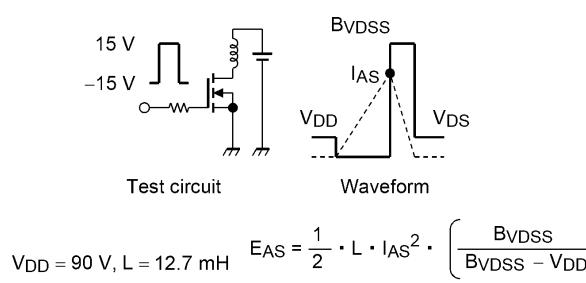
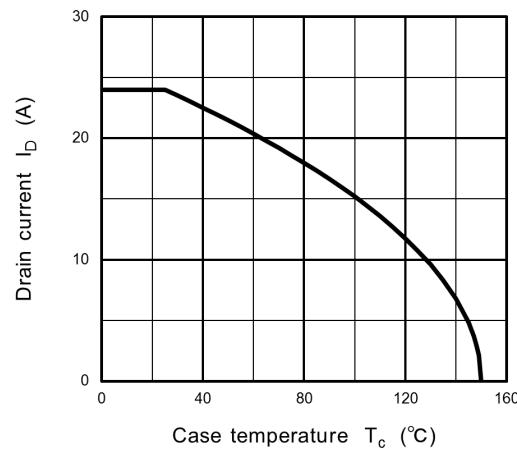
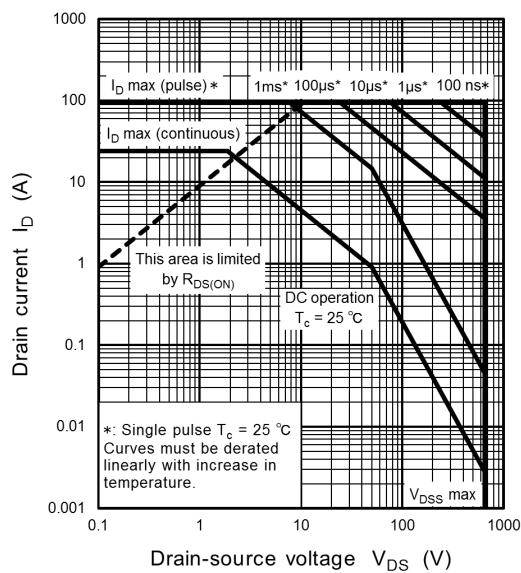


Fig. 8.16 Test Circuit/Waveform



**Fig. 8.17 $I_D - T_c$
(Guaranteed Maximum)**

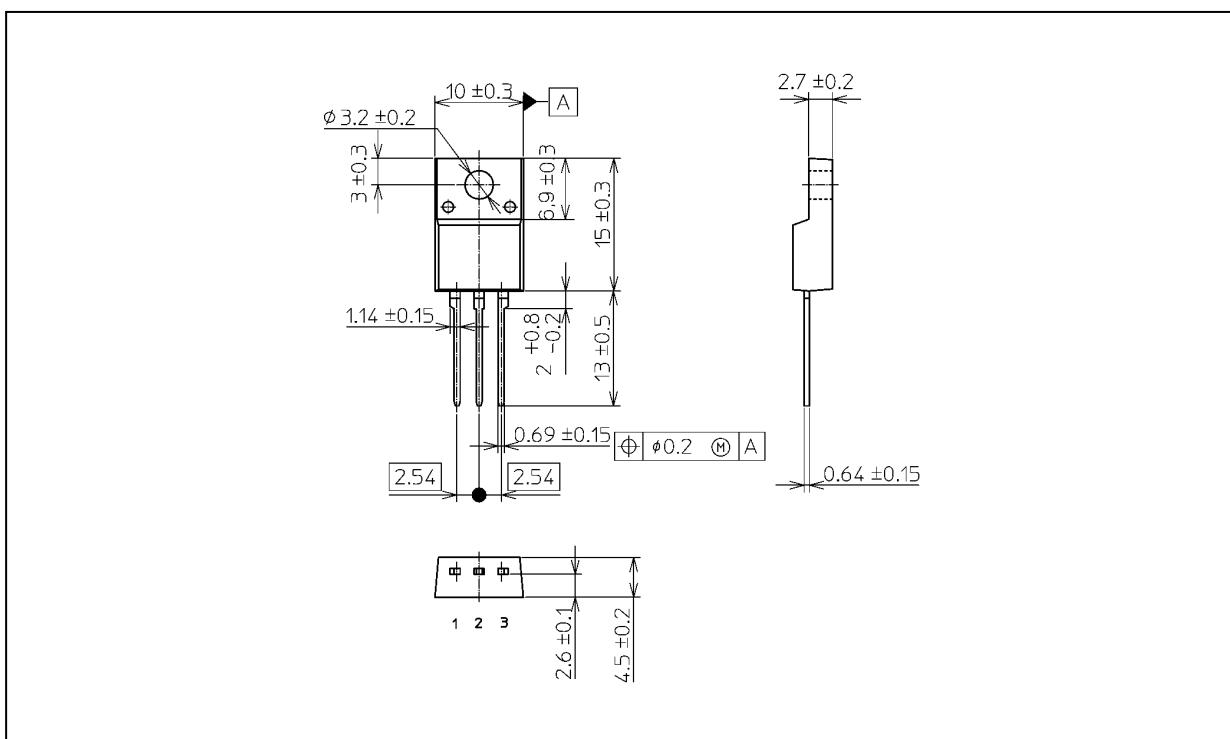


**Fig. 8.18 Safe Operating Area
(Guaranteed Maximum)**

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

Unit: mm



Weight: 1.7 g (typ.)

Package Name(s)
JEITA: SC-67
TOSHIBA: 2-10U1S
Nickname: TO-220SIS

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